# onsemi

# **<u>MOSFET</u> - Power, Single N-Channel, DFN5/DFNW5** 40 V, 3.7 mΩ, 87 A

# NVMFS5C456NL

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- NVMFS5C456NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS	(T <sub>J</sub> = 25°	C unless other	wise noted)			
Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V <sub>DSS</sub>	40	V	
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V	
Continuous Drain		$T_{C} = 25^{\circ}C$	I <sub>D</sub>	87	А	
Current R <sub>θJC</sub> (Notes 1, 3)	Steady State	T <sub>C</sub> = 100°C		61		
Power Dissipation		T <sub>C</sub> = 25°C	PD	55	W	
R <sub>θJC</sub> (Note 1)		$T_{\rm C}$ = 100°C		27		
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	Ι <sub>D</sub>	22	А	
Current R <sub>θJA</sub> (Notes 1, 2, 3)		T <sub>A</sub> = 100°C		16		
Power Dissipation		T <sub>A</sub> = 25°C	PD	3.6	W	
R <sub>θJA</sub> (Notes 1 & 2)		T <sub>A</sub> = 100°C		1.8		
Pulsed Drain Current	T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	520	А	
Operating Junction and Storage Temperature		T <sub>J</sub> , T <sub>stg</sub>	–55 to + 175	°C		
Source Current (Body Diode)			۱ <sub>S</sub>	61	А	
Single Pulse Drain-to-Source Avalanche Energy ( $I_{L(pk)} = 5 A$ )		E <sub>AS</sub>	202	mJ		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C		

MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

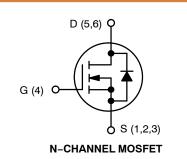
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	2.7	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	42	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
40 V	$3.7~\mathrm{m}\Omega$ @ 10 V	87 A
40 V	6.0 mΩ @ 4.5 V	07 A

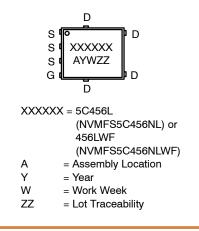




DFN5 (SO-8FL) CASE 488AA

DFNW5 (FULL-CUT SO8FL WF) CASE 507BE

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information on page 5 of this data sheet.

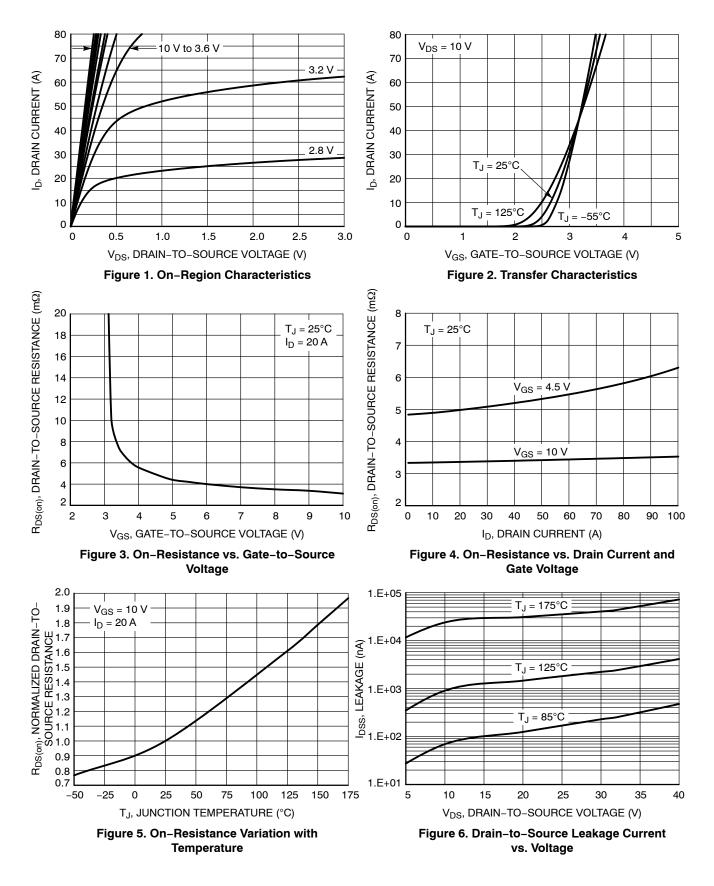
#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				22		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 25 °C			10	μΑ
		V <sub>DS</sub> = 40 V	T <sub>J</sub> = 125°C			250	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA
ON CHARACTERISTICS (Note 4)	-			-		-	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D = 50 \ \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-5.1		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 20 A		4.8	6.0	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A		3.1	3.7	mΩ
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> =15 V, I <sub>D</sub> = 40 A			80		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE			-		-	
Input Capacitance	C <sub>ISS</sub>				1600		
Output Capacitance	C <sub>OSS</sub>	V <sub>GS</sub> = 0 V, f = 1 MH	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 25 V		590		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				21		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 20 V; $I_{D}$ = 40 A			18		nC
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 4.5 V, $V_{DS}$ = 20 V; $I_{D}$ = 40 A			8.2		nC V
Threshold Gate Charge	Q <sub>G(TH)</sub>				2		
Gate-to-Source Charge	Q <sub>GS</sub>				3.8		
Gate-to-Drain Charge	Q <sub>GD</sub>				2.1		
Plateau Voltage	V <sub>GP</sub>				3.2		
SWITCHING CHARACTERISTICS (Note 5	5)			-		-	
Turn-On Delay Time	t <sub>d(ON)</sub>				9.3		
Rise Time	tr	V <sub>GS</sub> = 4.5 V, V <sub>I</sub>			100		1
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$V_{GS}$ = 4.5 V, $V_{DS}$ = 20 V, I <sub>D</sub> = 40 A, R <sub>G</sub> = 1 $\Omega$			17		- ns
Fall Time	t <sub>f</sub>				4		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.86	1.2	
	$I_{\rm S} = 40  {\rm A}$	T <sub>J</sub> = 125°C		0.75		V	
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/µs, I <sub>S</sub> = 40 A			29		ns
Charge Time	ta				14		
Discharge Time	t <sub>b</sub>				15		
Reverse Recovery Charge	Q <sub>RR</sub>				20		nC

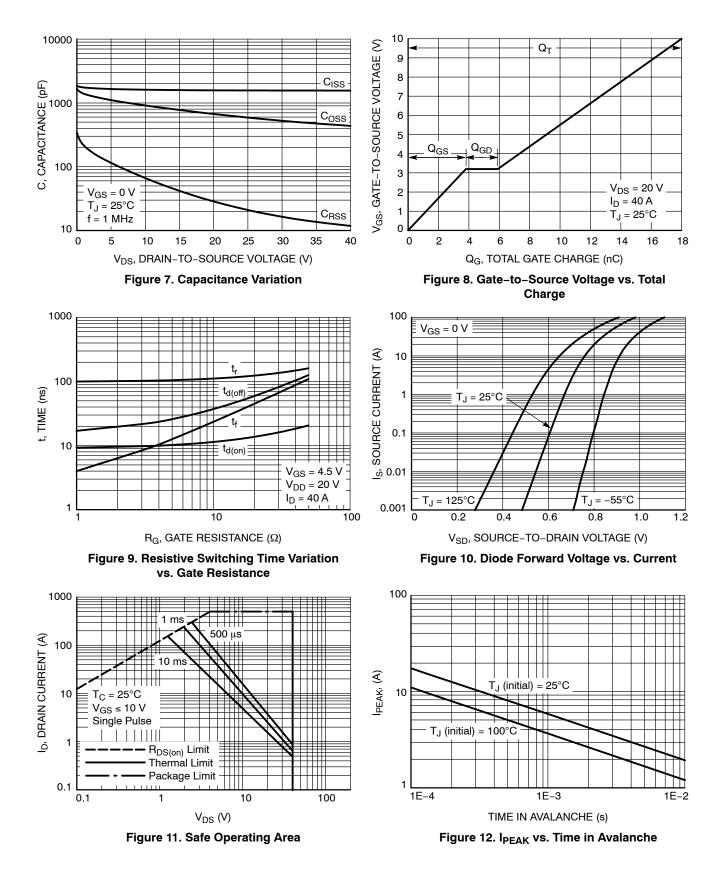
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ . 5. Switching characteristics are independent of operating junction temperatures.



### **TYPICAL CHARACTERISTICS**



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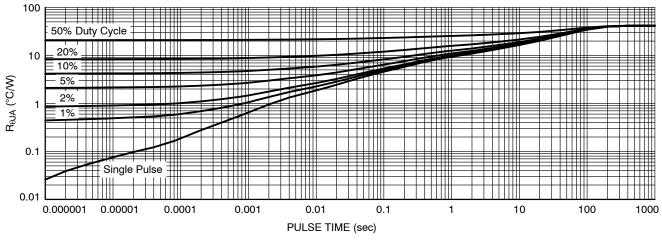


Figure 13. Thermal Characteristics

Device	Marking Package		Shipping <sup>†</sup>	
NVMFS5C456NLET1G-YE	5C456L	DFN5 (Pb–Free)	1500 / Tape & Reel	
NVMFS5C456NLT1G	5C456L	DFN5 (Pb–Free)	1500 / Tape & Reel	
NVMFS5C456NLWFT1G	456LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C456NLT3G	5C456L	DFN5 (Pb-Free)	5000 / Tape & Reel	
NVMFS5C456NLWFT3G	456LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel	
NVMFS5C456NLAFT1G	5C456L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C456NLAFT1G-YE	5C456L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C456NLWFAFT1G	456LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C456NLWFET1G	456LWF	DFNW5 1500 / Tape & (Pb-Free, Wettable Flanks)		
NVMFS5C456NLWFET3G	456LWF	DFNW5 5000 / Tape & (Pb-Free, Wettable Flanks)		

#### **DEVICE ORDERING INFORMATION**

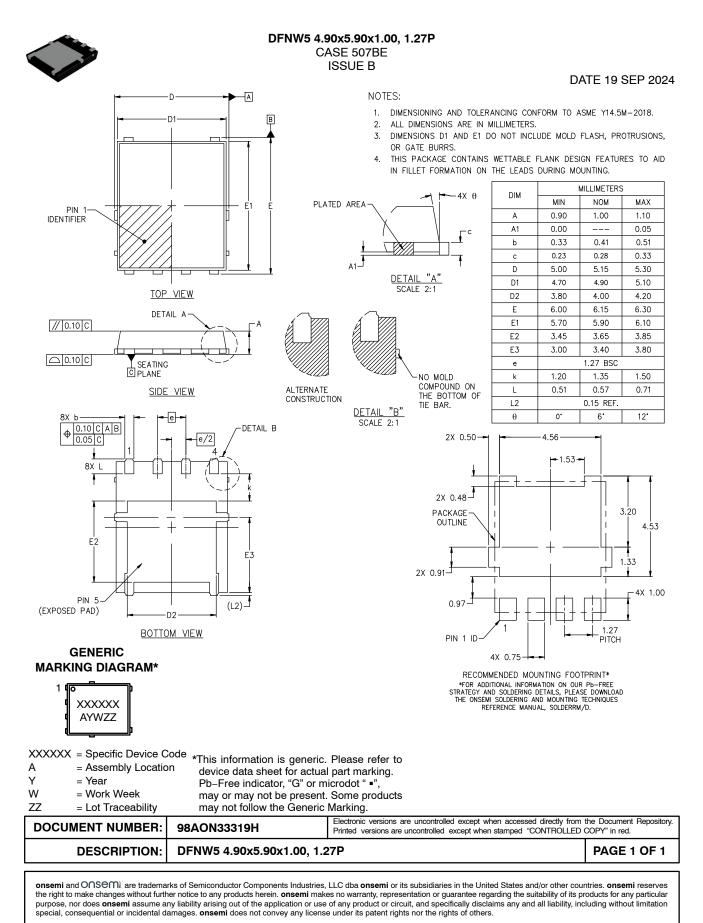
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



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